

(19) United States

(12) Patent Application Publication (10) Pub. No.: US 2022/0352870 A1 HUANG et al.

Nov. 3, 2022 (43) **Pub. Date:**

(54) COMPOSITE SUBSTRATE, SURFACE ACOUSTIC WAVE RESONATOR, AND FABRICATING METHODS THEREOF

(71) Applicant: Ningbo Semiconductor International

Corporation, Ningbo (CN)

(72) Inventors: Herb He HUANG, Ningbo (CN); Hailong LUO, Ningbo (CN); Wei LI,

Ningbo (CN); Fei QI, Ningbo (CN)

(21) Appl. No.: 17/867,629

(22) Filed: Jul. 18, 2022

Related U.S. Application Data

(63) Continuation of application No. PCT/CN2020/ 135659, filed on Dec. 11, 2020.

(30)Foreign Application Priority Data

(CN) 202010054453.8

Publication Classification

(51) Int. Cl. H03H 9/02 (2006.01)H03H 3/08 (2006.01)H03H 9/25 (2006.01)

U.S. Cl.

CPC H03H 9/02574 (2013.01); H03H 3/08 (2013.01); H03H 9/02559 (2013.01); H03H 9/02637 (2013.01); H03H 9/25 (2013.01)

(57)ABSTRACT

A composite substrate, a surface acoustic wave resonator and their fabricating method are provided. The fabricating method of the composite substrate includes: providing a first substrate; forming a liner layer including at least a polycrystalline material layer on the first substrate; depositing a piezoelectric sensing film for generating acoustic resonance on the polycrystalline material layer by a physical or chemical deposition method; and performing recrystallization annealing treatment on the piezoelectric sensing film, to make the piezoelectric sensing film reach a polycrystalline state. The recrystallization annealing treatment includes a heating process and a cooling process, and the heating process includes heating the piezoelectric sensing film to make the piezoelectric sensing film reach a molten state.

